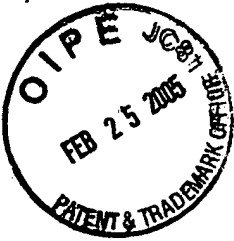


# PETITION FOR EXTENSION OF TIME UNDER 37 CFR 1.136(a)

Docket Number (Optional)  
01-615



In re Application of **HAMASAKI**

Application Number **10/814,180**

Filed: **4/1/2004**

For **METHOD OF RESIN-SEALING A SEMICONDUCTOR DEVICE, AND FORMING DIE FOR RESIN SEALING THE SEMICONDUCTOR DEVICE**

Group Art Unit  
**2825**

Examiner **MALSAWMA**

This is a request under the provisions of 37 CFR 1.136(a) to extend the period for filing a response in the above identified application.

The requested extension and appropriate non-small-entity fee are as follows.  
(check time period desired):

- ☒ One month (37 CFR 1.17(a)(1)) \$ 120.00
- ☐ Two months (37 CFR 1.17(a)(2)) \$ 450.00
- ☐ Three months (37 CFR 1.17(a)(3)) \$ 1020.00
- ☐ Four months (37 CFR 1.17(a)(4)) \$ 1,590.00
- ☐ Five months (37 CFR 1.17(a)(5)) \$ 2160.00
- ☐ Applicant is a small entity under 37 CFR 1.9 and 1.27, therefore the fee amount shown above is reduced by one-half, and the resulting fee is: \$           .

A small entity statement under 37 CFR 1.27:

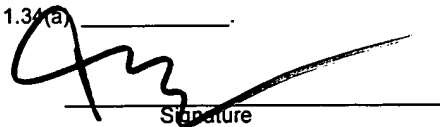
- ☐ is enclosed.
- ☐ has already been filed in this application.
- ☒ A check in the amount of the fee is enclosed.
- ☐ The Director has already been authorized to charge fees in this application to a Deposit Account.
- ☒ The Director is hereby authorized to charge any fees which may be required, or credit any overpayment, to Deposit Account Number 50-1147. I have enclosed a duplicate copy of this sheet.

I am the ☐ assignee of record of the entire interest.

- ☐ applicant.
- ☒ attorney or agent of record.
- ☐ attorney or agent under 37 CFR 1.34(a).

Registration number if acting under 37 CFR 1.34(a)           

Date 25 February 2005

  
Signature

Robert L. Scott, II (Reg. No. 43,102)

Typed or printed name

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